

(19) World Intellectual Property Organization  
International Bureau(43) International Publication Date  
18 January 2001 (18.01.2001)

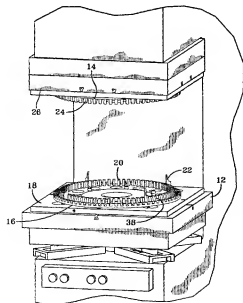
PCT

(10) International Publication Number  
**WO 01/03912 A1**

- (51) International Patent Classification<sup>7</sup>: **B29D 31/00**, B29C 43/36, B29D 30/48, B29C 70/46
- (21) International Application Number: PCT/US99/15940
- (22) International Filing Date: 13 July 1999 (13.07.1999)
- (25) Filing Language: English
- (26) Publication Language: English
- (71) Applicant (for all designated States except US): **THE GOODYEAR TIRE & RUBBER COMPANY** [US/US]; 1144 East Market Street, Akron, OH 44316-0001 (US).
- (72) Inventors; and
- (75) Inventors/Applicants (for US only): **REX, William, Allen** [US/US]; 18220 William Drive, Doylestown, OH 44230 (US). **CONGER, Kenneth, Dean** [US/US]; 1332 Homestead Drive, Stow, OH 44303 (US). **WILSON, Brian, Joseph** [US/US]; 52 Royal Avenue, Akron, OH 44303 (US).
- (74) Agent: **LACHER, Frederick, K.**; Brown, Robert, W., The Goodyear Tire & Rubber Company, Patent Counsel, 1144 East Market Street, Akron, OH 44316-0001 (US).
- (81) Designated States (national): AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, CA, CH, CN, CU, CZ, DE, DK, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MD, MG, MK, MN, MW, MX, NO, NZ, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TR, TT, UA, UG, US, UZ, VN, YU, ZW.
- (84) Designated States (regional): ARIPO patent (GH, GM, KE, LS, MW, SD, SL, SZ, UG, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GW, ML, MR, NE, SN, TD, TG).
- Published:**  
— With international search report.
- For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: BEAD CURING FINGER MOLD

(57) Abstract: A tire bundle is molded in a mold cavity formed by closing a mold having upper and lower mold halves with intermeshing fingers (20, 24) for enclosing bead wires and providing a molded bead ring for placing in a bead apex mold.



WO 01/03912 A1

**BEAD CURING FINGER MOLD****Technical Field**

This invention related to molding a tire bead and especially to curing the rubber coating on the bead wires of a bead bundle which is held in a predetermined shape. The bead wires are held in place during the vulcanization so that when the bead ring is placed in a mold for injection molding of an apex on the bead, the mold will not be damaged by out of place wires. The bead bundle is also cured in a circular shape so that problems with pinching out of round beads are avoided during the closing of the bead apex mold.

**Background Art**

Heretofore as shown and described in U.S. Patent No. 5,798,127, a bead bundle of rubber coated bead wires has been placed in an apex mold and held in position by blades engaging the radially inner surface of the tire bead bundle. The apex-bead assembly is then formed by injection of rubber into the apex mold cavity of the apex mold. If the bead wires extend outwardly from the bead bundle, the mold may be damaged during closing causing shut down and costly repairs. With this method the unvulcanized bead bundle may be changed in shape by handling before placing in the apex mold. Also the bead bundle may be distorted and come apart during the injection process when rubber is being injected past the bead at high velocity and with great force.

In U.S. Patent No. 5,262,115, an apex bead assembly mold for injection molding the apex assembly is shown where the rubber coated bead bundles are held in place on a cylindrical core by spaced-apart coaxial round rings arranged in side by side relation and engaging the axially extending inner surfaces and the radially extending inner surfaces of the beads so that when half molds are mounted around the core with the beads held in place, apex portions may be injection molded. Thereafter, the mold halves are removed and the bead apex assemblies pulled off the rings. During the injection process the unprotected bead bundle of unvulcanized rubber may be distorted or come apart due to high velocity movement of the rubber past of the bead.

**Disclosure of the Invention**

This invention relates to a mold for heating and enclosing a circular member comprising a first mold member, a second mold member movable into engagement with the first mold member to provide a mold cavity characterized by the first mold member having a plurality circumferentially spaced first fingers, the second mold member having a plurality of circumferentially spaced second fingers movable into meshing engagement with the first fingers

upon closing of the mold by movement of the first mold member towards the second mold member providing a circular mold cavity for the circular member.

This invention further relates to a bead curing finger mold characterized by a plurality of circumferentially spaced lower fingers disposed in a lower ring, a plurality of circumferentially spaced upper fingers disposed in an upper ring, the lower ring being positioned in a generally horizontal position for supporting a bead bundle, and the upper ring being positioned over the lower ring with the lower fingers interposed between the upper fingers in a closed position of the mold for containing and guiding the bead bundle and providing spaces along the lower fingers and the upper fingers to accommodate variations in size of the bead bundle.

This invention is also directed to the construction of a tire bead comprising multiple revolutions of metal wires coated with rubber and wound in a circular configuration to form a bead bundle characterized by the bead bundle being cured in a bead curing finger mold having a plurality of circumferentially spaced lower fingers disposed in a lower ring in a generally horizontal lower position for supporting the bead bundle, a plurality of circumferentially spaced upper fingers disposed in a generally horizontal upper ring positioned over the lower ring with the lower fingers interposed between the upper fingers in the closed position of the mold for containing and guiding the wires of the bead bundle and providing spaces along the lower fingers and the upper fingers to accommodate variations in size of the bead bundle during vulcanization of the bead upon application of heat to bead curing finger mold.

#### **Brief Description of Drawings**

Fig. 1 is a front view in perspective of a finger mold embodying the invention shown mounted in a press.

Fig. 2 is an elevation with parts broken away of the upper and lower mold halves shown in Fig. 1 removed from the press with the bead ring shown lifted from the lower mold.

Fig. 3 is a cross sectional view of the molds taken along the plane of line 3-3 in Fig. 2.

Fig. 4 is a plan view of the lower mold half taken along the plane of line 4-4 in Fig. 2.

Fig. 5 is an enlarged fragmentary sectional view of the spring for removing the bead from the upper mold half.

Fig. 6 is an enlarged fragmentary schematic sectional view of the upper and lower finger mold halves shown in Fig. 2 with the bead bundle held by the fingers without bottoming of the finger mold halves.

Fig. 7 is a view like Fig. 6 showing the bead ring after molding and before removal from the lower finger mold half.

### **Detailed Description of the Invention**

Referring to Fig. 1, a bead curing finger mold 10 embodying the invention is mounted in a hydraulic press 12 and has an upper finger mold half 14 and a lower finger mold half 16 movable together and apart upon opening and closing of the press. In the embodiment shown, the press 12 provides a pressure of 7 tons (7.11 metric tons) plus or minus 5 tons (5.08 metric tons) and the diameter of the bead is 22.50 inches (57.15 cm), however, with this press, medium radial truck tire beads of diameters having a range of 17.50 inches (44.45cm) to 24.5 inches (62.23 cm) may be molded with finger molds of this type.

Referring to Figs. 1-4, the lower finger mold half 16 is mounted on a bottom press plate 18 and includes a plurality of circumferentially spaced apart lower fingers 20. Vertically movable ejector and bead holders 22 are mounted in the bottom press plate 18 at circumferentially spaced positions around the lower finger mold half 16 for holding a bead bundle 23 prior to closing the press 12 and ejecting the vulcanized bead after the curing cycle.

Referring to Figs. 2, 3 and 5, the upper finger mold half 14 has a plurality of circumferentially spaced upper fingers 24 mounted on a top press plate 26 of the press 12. Four spaced apart upper ejector fingers 27 are individually slidably supported and are spring loaded on the upper finger mold half 14 and have four posts 28 slidably mounted in collars 30, fastened to the upper finger mold half 14. Coil springs 32 are disposed between the collars 30 and the upper ejector fingers 27 to urge the ejector fingers downward into engagement with the bead bundle 23 to eject the bead bundle and separate the bead bundle from the upper mold half 14 as the mold 10 opens. In operation, the press 12 is opened to the position shown in Fig. 1 with the ejector and bead holders 22 in a position above the lower finger mold half 16. The bead bundle 23 is then placed over the lower fingers 20 on the bead holders 22. The bead bundle 23 comprises a ring of bead wires wound and coated with rubber in a bead ring in a manner well-known in the art. The bottom press plate 18 is then raised vertically lifting the bead bundle 23 off the ejector and bead holders 22. As shown in Fig. 7, tapered side surfaces 38 of the lower fingers 20 preferably have the same slope as a bead surface 40 relative to the axial direction A-A, which in this embodiment is an angle X of 15 degrees. However, in other embodiments, this angle may range from 0 to 45 degrees. The angle X is normally the same angle as the angle of the surface of the rim of the wheel on which the tire having this bead bundle 23 is mounted.

The press 12 is closed with the bottom mold plate 18 raised into a seating position with the top press plate 26. The lower finger mold half 16 is raised into position so that the lower fingers 20 are in meshing engagement with the upper fingers 24 as shown in Fig. 6. Steam or other heat transmitting material may then be provided in the press for vulcanizing the bead bundle 23 into a compact bead.

As shown in Figs. 6 and 7, during the closing operation the movement of the lower finger mold half 14 upward towards the upper finger mold half 14 is stopped by the compression of the bead bundle 23. There is no bottoming out of the upper finger mold half 14 against the lower finger mold half 16. This is advantageous because it provides a compact bead ring even though there may be variations in the size of the bead bundle 23. Variations may be accommodated in spaces 40 at the edges of the upper fingers 24 and lower fingers 20.

After vulcanization, the press 12 is opened and the springs 32 urge the ejector fingers 27 downward ejecting the bead bundle 23 as the press 12 opens. The ejector and bead holders 22 protrude through the lower finger mold half 16 and lift the vulcanized bead bundle 23 to the position shown in Figs. 2 and 3 as the bottom mold plate 18 is lowered.

While a certain representative embodiment and details have been shown for the purpose of illustrating the invention, it will be apparent to those skilled in the art that various changes and modifications may be made therein without departing from the spirit or scope of the invention.

Having thus described the invention it is now claimed:

## CLAIMS

1. A mold for heating and enclosing a circular member comprising an upper finger mold half, a lower finger mold half movable into engagement with said upper finger mold half to provide a mold cavity characterized by said upper finger mold half having a plurality of circumferentially spaced upper fingers, said lower finger mold half having a plurality of circumferentially spaced lower fingers movable into meshing engagement with said upper fingers upon closing of said mold by movement of said lower finger mold half towards said upper finger mold half providing a circular mold cavity for said circular member.

2. A mold according to claim 1 further characterized by said upper fingers and said lower fingers having sloped edges for guiding and compressing said circular member in a central position upon closing of said mold.

3. A mold according to claim 2 further characterized by said upper fingers and said lower fingers having molding surfaces providing a circumferentially continuous molding member surface of said mold with a precise predetermined diameter of said circular member upon closing of said mold.

4. A mold according to claim 3 wherein said circular member is a tire bead having a plurality of wires wrapped in a bead bundle and coated with a resilient rubber-like material further characterized by means for heating said mold for vulcanizing said resilient rubber-like material.

5. A mold according to claim 3 further characterized by said upper fingers and said lower fingers having extensions extending beyond said molding surfaces for guiding said circular member and providing recesses for receiving said extensions in the closed condition of said mold.

6. A bead curing finger mold characterized by a plurality of circumferentially spaced lower fingers disposed in a lower finger mold half, a plurality of circumferentially spaced upper fingers disposed in an upper finger mold half, said lower finger mold half being positioned in a generally horizontal position for supporting a bead bundle, and said upper finger mold half being positioned over said lower finger mold half with said lower fingers being interposed between said upper fingers in a closed position of said mold for containing and guiding said bead bundle and providing spaces along said lower fingers and said upper fingers to accommodate variations in size of said bead bundle.

7. A bead curing finger mold according to claim 6 further characterized by said lower finger mold half being raised to close said mold and said upper finger mold half has spaced apart spring

loaded ejector fingers for retracting upon closing of said mold and for extension upon opening of said mold to transfer said bead bundle to said lower finger mold half.

8. A bead curing finger mold according to claim 6 further characterized by said lower finger mold half having circumferentially spaced apart ejectors and bead holders extending upwardly through said lower finger mold half for holding said bead bundle in the lower position of said lower finger mold half prior to closing of said mold and ejecting said bead bundle upon lowering of said upper mold half after vulcanization of said bead bundle.

9. A tire bead comprising multiple revolutions of metal wires coated with rubber and wound in a circular configuration to form a bead bundle characterized by said bead bundle being cured in a bead curing finger mold having a plurality of circumferentially spaced lower fingers disposed in a lower finger mold half in a generally horizontal lower position for supporting said bead bundle, a plurality of circumferentially spaced upper fingers disposed in a generally horizontal upper finger mold half positioned over said lower finger mold half with said lower fingers interposed between said upper fingers in the closed position of said mold for straightening said wires of said bead bundle and providing spaces along said lower fingers and said upper fingers to accommodate variations in size of said bead bundle during vulcanization of said bead upon application of heat to said bead curing finger mold.

10. The tire bead of Fig. 9 further characterized by said lower fingers and said upper fingers having tapered bead bundle engaging surfaces in converging relationship upon closing movement of said upper finger mold half and said lower finger mold half for compressing said metal wires during closing of said bead curing finger mold.

11. The tire bead bundle, according to claim 10 further characterized by said lower fingers and said upper fingers having radially extending surfaces for overlapping said bead during closing of said finger mold to limit the closing movement of said lower finger mold half relative to said upper finger mold half and determine the closing movement of the bead curing finger mold.

12. A tire bead according to claim 10 wherein the angle of taper is from 0 to 45 degrees from a vertical axis of said lower finger mold half.

13. A tire bead according to claim 12 further characterized by the angle of taper being 15 degrees.

14. A method and apparatus substantially as described herein or as shown in the accompanying drawings.

1/6

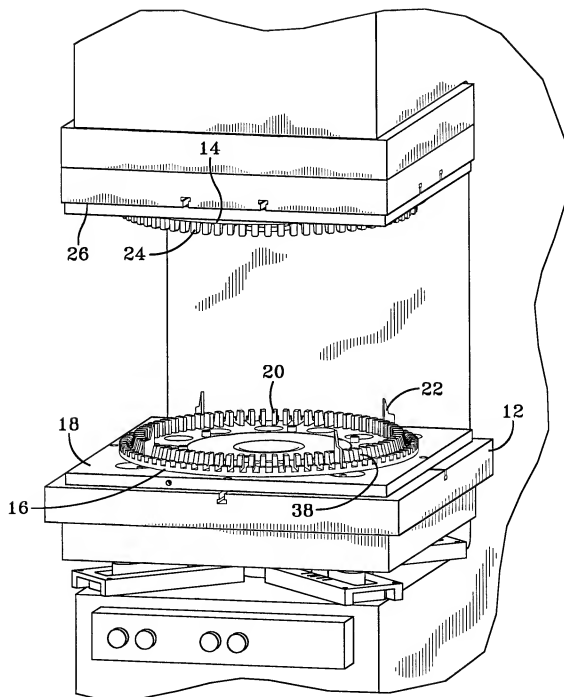


FIG-1



2/6

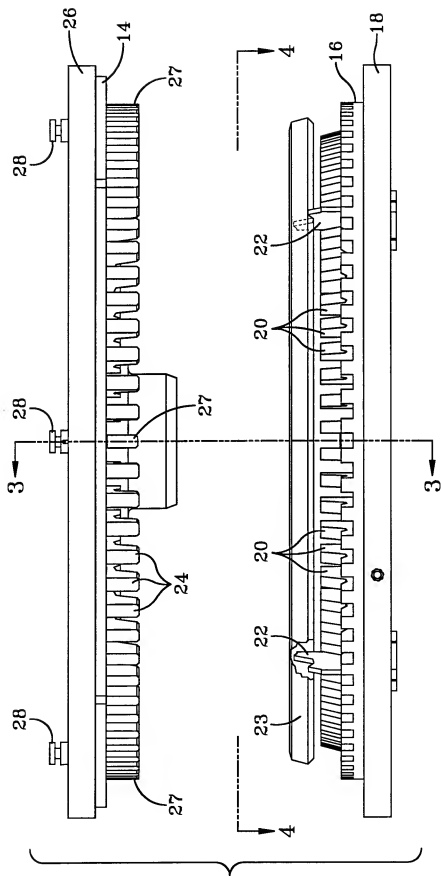


FIG-2

3/6

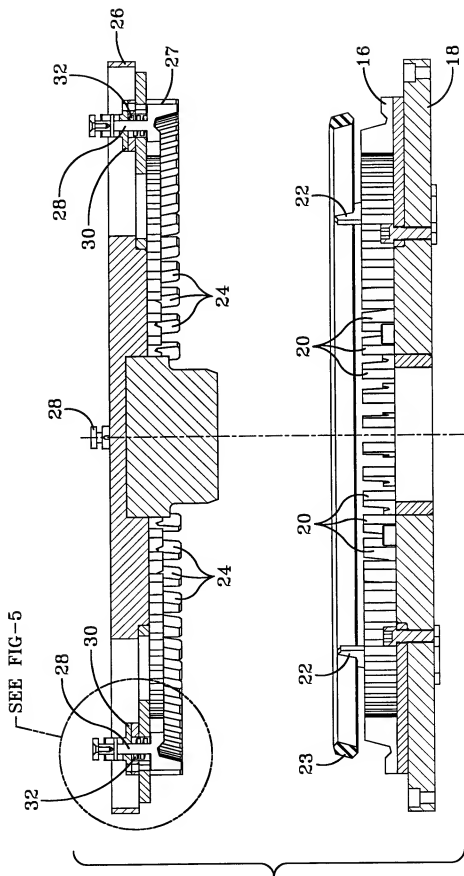


FIG-3

4/6

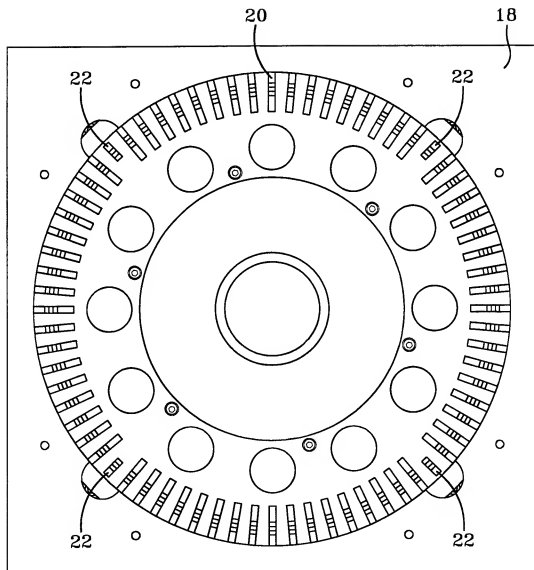


FIG-4

5/6

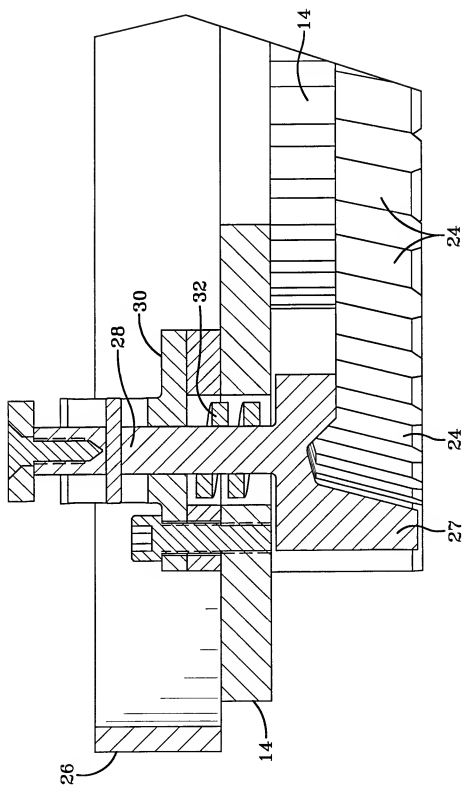


FIG-5

6/6

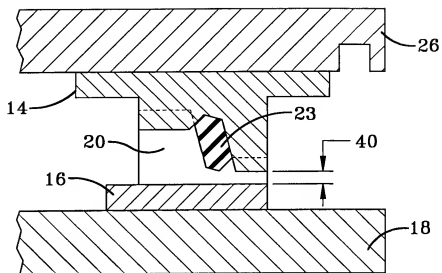


FIG-6

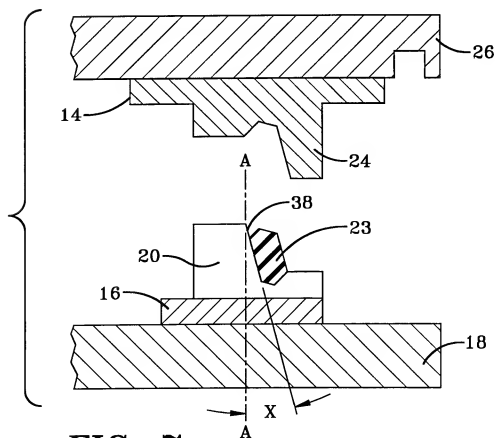


FIG-7

## INTERNATIONAL SEARCH REPORT

 Internat'l Application No  
 PCT/US 99/15940

 A. CLASSIFICATION OF SUBJECT MATTER  
 IPC 7 B29D31/00 B29C43/36 B29D30/48 B29C70/46

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

 Minimum documentation searched (classification system followed by classification symbols)  
 IPC 7 B29D B29C

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category *	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	US 4 510 113 A (TAKANO HIROSHI ET AL) 9 April 1985 (1985-04-09) column 3, line 47 -column 6, line 24 figures 2,3 ---	1-3,6
A	PATENT ABSTRACTS OF JAPAN vol. 009, no. 003 (M-349), 9 January 1985 (1985-01-09) & JP 59 155028 A (SUMITOMO GOMU KOGYO KK), 4 September 1984 (1984-09-04) abstract -----	1-14

☐ Further documents are listed in the continuation of box C.

☒ Patent family members are listed in annex

## \* Special categories of cited documents:

- "A" document defining the general state of the art which is not considered to be of particular relevance  
 "E" earlier document but published on or after the international filing date  
 "L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or other special reason (as specified)  
 "O" document referring to an oral disclosure, use, exhibition or other means  
 "P" document published prior to the international filing date but later than the priority date claimed

- "T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention  
 "X" document of particular relevance; the claimed invention cannot be considered novel or cannot be considered to involve an inventive step when the document is taken alone  
 "Y" document of particular relevance; the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art  
 "Z" document member of the same patent family

Date of the actual completion of the international search

Date of mailing of the international search report

9 February 2000

16/02/2000

 Name and mailing address of the ISA  
 European Patent Office, P.B. 5818 Patentlaan 2  
 NL - 2280 HV Rijswijk  
 Tel. (+31-70) 340-2040, Tx. 31 651 epo nl,  
 Fax: (+31-70) 340-3016

Authorized officer

Bibollet-Ruche, D

# INTERNATIONAL SEARCH REPORT

Information on patent family members

International Application No

PCT/US 99/15940

Patent document cited in search report	Publication date	Patent family member(s)	Publication date
US 4510113 A	09-04-1985	JP 1456712 C	09-09-1988
		JP 58163638 A	28-09-1983
		JP 63002773 B	20-01-1988
		AT 20851 T	15-08-1986
		CA 1212807 A	21-10-1986
		EP 0090601 A	05-10-1983
JP 59155028 A	04-09-1984	JP 1497007 C	16-05-1989
		JP 63044057 B	02-09-1988